

N-channel 80 V 11 m Ω standard level MOSFET

Rev. 02 — 25 June 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

High efficiency due to low switching and conduction losses

1.3 Applications

- DC-to-DC converters
- Load switching

1.4 Quick reference data

 Suitable for standard level gate drive sources

nexperia

- Motor control
- Server power supplies

Table 1.	Quick reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	80	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>		-	-	74	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	148	W
Dynamic	characteristics						
Q _{GD}	gate-drain charge	$\label{eq:V_GS} \begin{array}{l} V_{GS} = 10 \text{ V}; \ I_D = 25 \text{ A}; \\ V_{DS} = 40 \text{ V}; \ see \ \underline{Figure \ 14}; \\ see \ \underline{Figure \ 15} \end{array}$		-	9.4	-	nC
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I _D = 15 A; T _j = 25 °C;	[1]	-	9	11	mΩ

[1] Measured 3 mm from package.

N-channel 80 V 11 m Ω standard level MOSFET

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source		
3 mb	D	mounting base; connected to drain		mbb076 S
			SOT78	

(TO-220AB; SC-46)

3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PSMN012-80PS	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78		

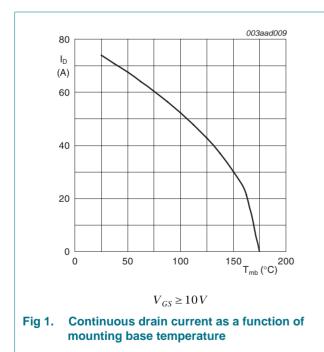
N-channel 80 V 11 mΩ standard level MOSFET

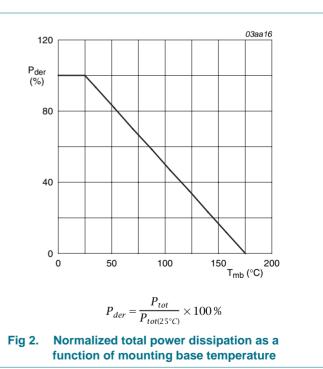
4. Limiting values

Table 4.Limiting values

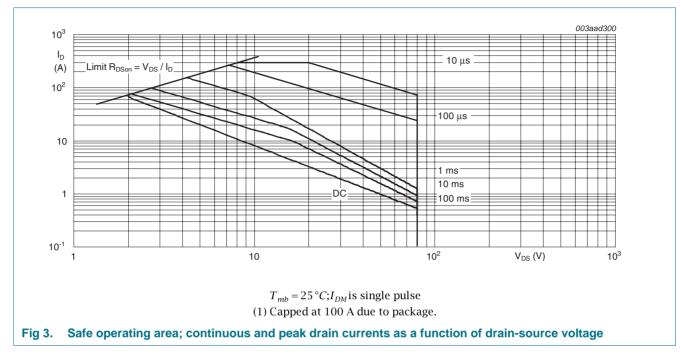
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	80	V
V _{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$	-	80	V
V _{GS}	gate-source voltage		-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u>	-	52	А
		V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u>	-	74	А
I _{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3	-	295	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	148	W
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-dr	ain diode				
I _S	source current	T _{mb} = 25 °C	-	74	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	295	А
Avalanche	e ruggedness				
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 74 A; V_{sup} \leq 80 V; R_{GS} = 50 $\Omega;$ unclamped	-	100	mJ





N-channel 80 V 11 mΩ standard level MOSFET



5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	0.65	1	K/W

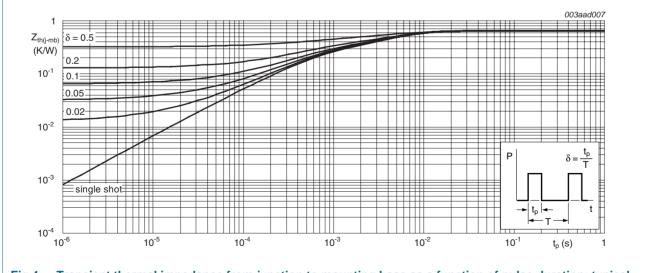


Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration; typical values

N-channel 80 V 11 mΩ standard level MOSFET

6. Characteristics

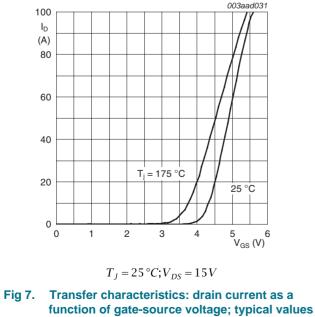
Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	aracteristics						
V _{(BR)DSS}	drain-source	I_D = 250 µA; V_{GS} = 0 V; T_j = -55 °C		73	-	-	V
	breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C		80	-	-	V
V _{GS(th)} gate-source th voltage	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		-	-	4.6	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		2	3	4	V
I _{DSS}	drain leakage current	$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	3	μA
		$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	60	μA
I _{GSS}	gate leakage current	V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C		-	-	100	nA
		$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 15 A; T _j = 100 °C; see <u>Figure 13</u>		-	-	18	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C	[2]	-	9	11	mΩ
R _G	internal gate resistance (AC)	f = 1 MHz		-	0.97	-	Ω
Dynamic	characteristics						
Q _{G(tot)}	total gate charge	$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$		-	36	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 14</u> ; see <u>Figure 15</u>		-	43	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$		-	12	-	nC
$Q_{GS(th)}$	pre-threshold gate-source charge	see <u>Figure 14;</u> see <u>Figure 15</u>		-	8	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge			-	4	-	nC
Q _{GD}	gate-drain charge			-	9.4	-	nC
V _{GS(pl)}	gate-source plateau voltage	$V_{DS} = 40 V$		-	4.5	-	V
C _{iss}	input capacitance	V _{DS} = 12 V; V _{GS} = 0 V; f = 1 MHz;		-	2782	-	pF
C _{oss}	output capacitance	$T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{100}$		-	384	-	рF
C _{rss}	reverse transfer capacitance			-	162	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 12 V; R_{L} = 0.5 Ω; V_{GS} = 10 V;		-	19	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \Omega$		-	16	-	ns
t _{d(off)}	turn-off delay time			-	33	-	ns
t _f	fall time			-	6	-	ns

Nexperia

PSMN012-80PS

N-channel 80 V 11 m Ω standard level MOSFET

Symbol	Characteristicscontin	Conditions		Min	Тур	Max	Unit
	rain diode	Conditions		141111	тур	IVIAN	Unit
/ _{SD}	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j =$ see <u>Figure 17</u>	= 25 °C;	-	0.86	1.2	V
r	reverse recovery time	$I_{\rm S} = 50 \text{ A}; \text{ dI}_{\rm S}/\text{dt} = 100 \text{ A}$	/µs; V _{GS} = 0 V;	-	45	-	ns
ک _r	recovered charge	$V_{DS} = 40 V$		-	64	-	nC
] Tested	to JEDEC standards where a	pplicable.					
] Measur	red 3 mm from package.						
		003aad029				003aad030	
250 I _D	10	$V_{GS}(V) = 15$	25 5	5.5 6	1 11	10	
(A)	7		R _{DSon} (mΩ)		AAA		
200	6.5		20				
		6			M		
150							
		5.5	15				
100							
100		5					
			10				
50		4.5	V _{GS} (V	/) = 15			
0	0 2 4 6	8	5 50	100	150 2	00 25	0
· · · · ·		8 V _{DS} (V) ¹⁰				I _D (A)	
	$T_j = 25 ^{\circ}C; t_p = 3$	00 µs		$T_j = 25 \circ C; t_p$	= 300µs		
	Output characteristics: d			irce on-state			unctior
f	unction of drain-source	voltage; typical values	of drain c	urrent; typica	al values	;	
		003aad031				003aad035	
100			4000			003440035	



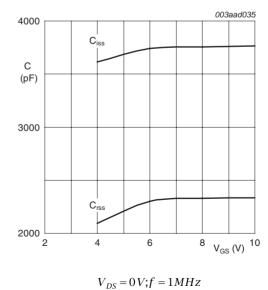


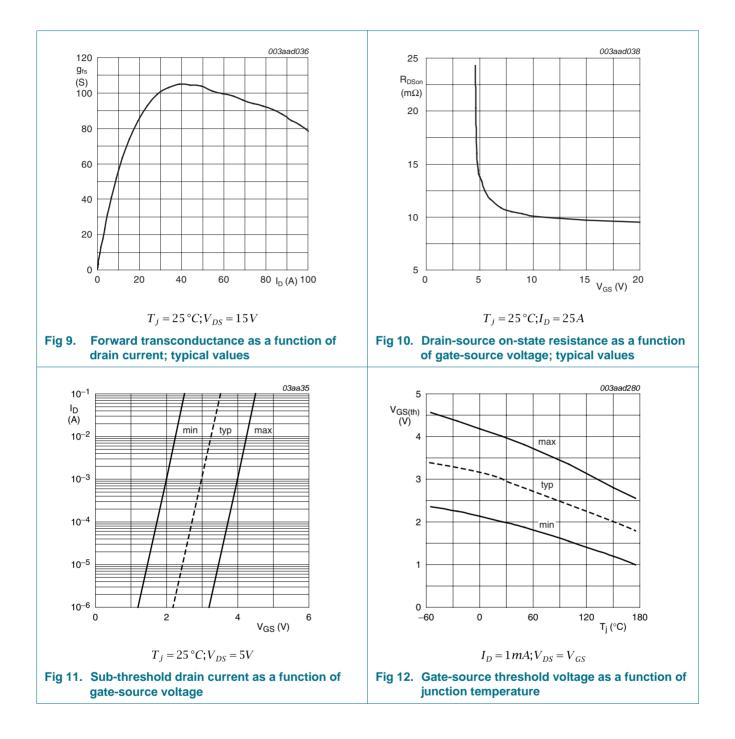
Fig 8. Input and reverse transfer capacitances as a function of gate-source voltage; typical values

PSMN012-80PS_2

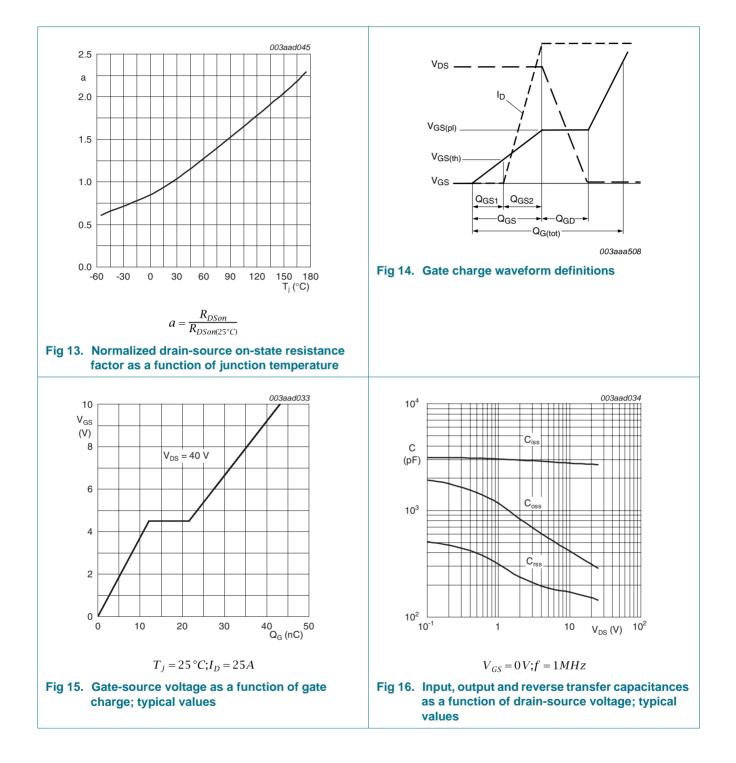
Nexperia

PSMN012-80PS

N-channel 80 V 11 mΩ standard level MOSFET



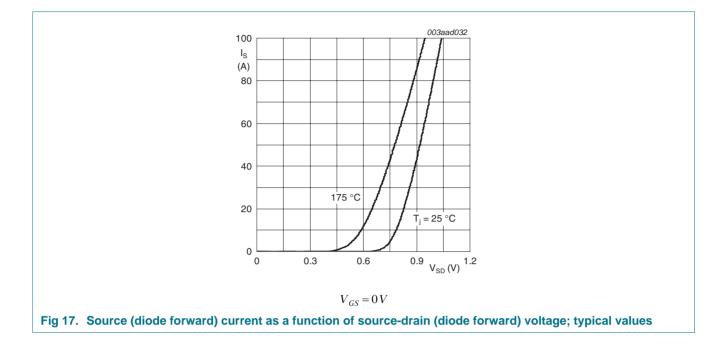
N-channel 80 V 11 mΩ standard level MOSFET



Nexperia

PSMN012-80PS

N-channel 80 V 11 m Ω standard level MOSFET



N-channel 80 V 11 mΩ standard level MOSFET

7. Package outline

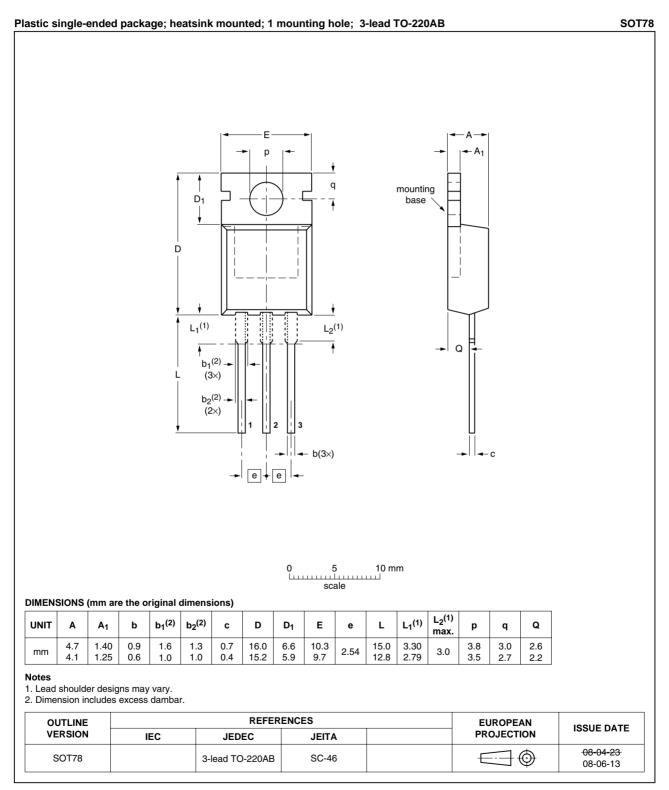


Fig 18. Package outline SOT78 (TO-220AB)

N-channel 80 V 11 mΩ standard level MOSFET

8. Revision history

Table 7.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN012-80PS_2	20090625	Product data sheet	-	PSMN012-80PS_1
Modifications:	 Various cl 	nanges to content.		
PSMN012-80PS_1	20090609	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

9.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

9.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of a Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia accepts no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk. **Applications** — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <u>http://www.nexperia.com/profile/terms</u>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by Nexperia. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

9.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

10. Contact information

For more information, please visit: http://www.nexperia.com

For sales office addresses, please send an email to: salesaddresses@nexperia.com

N-channel 80 V 11 m Ω standard level MOSFET

11. Contents

1	Product profile1
1.1	General description1
1.2	Features and benefits1
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Limiting values3
5	Thermal characteristics4
6	Characteristics5
7	Package outline10
8	Revision history11
9	Legal information12
9.1	Data sheet status12
9.2	Definitions12
9.3	Disclaimers
9.4	Trademarks12
10	Contact information12